SGM2045
300mA, Low V_{IN}, Ultra-Low Noise and High PSRR Linear Regulator

GENERAL DESCRIPTION

The SGM2045 is an ultra-low noise, low V_{IN}, high PSRR, high accuracy and low dropout voltage linear regulator. It is capable of supplying 300mA output current with typical dropout voltage of only 80mV. The operating input voltage range is from 1.1V to 5.5V and output voltage range is from 0.6V to 4.2V.

Other features include logic-controlled shutdown mode, short-circuit current limit and thermal shutdown protection. The SGM2045 has automatic discharge function to quickly discharge V_{OUT} in the disabled status.

The SGM2045 is suitable for application which needs low noise and fast transient response power supply, such as power supply of camera module in smart phone, etc.

The SGM2045 is available in Green XTDFN-1×1-4L and WLCSP-0.64×0.64-4B-A packages. It operates over an operating temperature range of -40℃ to +125℃.

FEATURES

- **Operating Input Voltage Range: 1.1V to 5.5V**
- **Fixed Output Voltage Option: 0.6V to 4.2V**
- **Ultra-Low Noise: 9.5μV_{RMS} (TYP)**
- **Ultra-Low Quiescent Current: 15μA (TYP)**
- **Standby Current: 0.03μA (TYP)**
- **High PSRR: 92dB (TYP) at 1kHz**
- **Low Dropout Voltage:**
  - **100mV (TYP) at 300mA when V_{OUT} = 1.8V (XTDFN-1×1-4L)**
  - **80mV (TYP) at 300mA when V_{OUT} = 1.8V (WLCSP-0.64×0.64-4B-A)**
- **Output Short-Circuit Protection**
- **Thermal Shutdown Protection**
- **Fast Load Transient Response**
- **Stable with 1μF Small Case Size Ceramic Capacitors**
- **-40℃ to +125℃ Operating Temperature Range**
- **Available in Green XTDFN-1×1-4L and WLCSP-0.64×0.64-4B-A Packages**

APPLICATIONS

Portable Electronic Devices
Smoke Detectors
IP Cameras
Wireless LAN Devices
Battery-Powered Equipment
Smartphones and Tablets
Digital Cameras and Audio Devices

TYPICAL APPLICATION

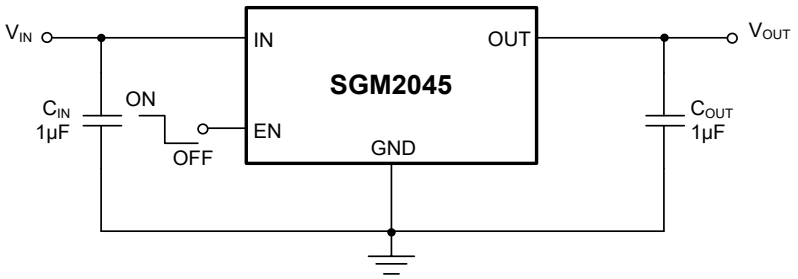
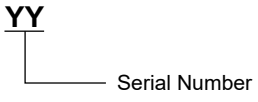


Figure 1. Typical Application Circuit

PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM2045-0.60	XTDFN-1×1-4L	-40℃ to +125℃	SGM2045-0.60XXDH4G/TR	08	Tape and Reel, 10000
SGM2045-0.75	XTDFN-1×1-4L	-40℃ to +125℃	SGM2045-0.75XXDH4G/TR	09	Tape and Reel, 10000
SGM2045-0.80	XTDFN-1×1-4L	-40℃ to +125℃	SGM2045-0.80XXDH4G/TR	10	Tape and Reel, 10000
SGM2045-0.85	XTDFN-1×1-4L	-40℃ to +125℃	SGM2045-0.85XXDH4G/TR	11	Tape and Reel, 10000
SGM2045-1.00	XTDFN-1×1-4L	-40℃ to +125℃	SGM2045-1.00XXDH4G/TR	12	Tape and Reel, 10000
SGM2045-1.05	XTDFN-1×1-4L	-40℃ to +125℃	SGM2045-1.05XXDH4G/TR	13	Tape and Reel, 10000
SGM2045-1.10	XTDFN-1×1-4L	-40℃ to +125℃	SGM2045-1.10XXDH4G/TR	15	Tape and Reel, 10000
SGM2045-1.20	XTDFN-1×1-4L	-40℃ to +125℃	SGM2045-1.20XXDH4G/TR	16	Tape and Reel, 10000
SGM2045-1.50	XTDFN-1×1-4L	-40℃ to +125℃	SGM2045-1.50XXDH4G/TR	MC	Tape and Reel, 10000
SGM2045-1.80	XTDFN-1×1-4L	-40℃ to +125℃	SGM2045-1.80XXDH4G/TR	17	Tape and Reel, 10000
SGM2045-2.50	XTDFN-1×1-4L	-40℃ to +125℃	SGM2045-2.50XXDH4G/TR	18	Tape and Reel, 10000
SGM2045-2.80	XTDFN-1×1-4L	-40℃ to +125℃	SGM2045-2.80XXDH4G/TR	19	Tape and Reel, 10000
SGM2045-3.00	XTDFN-1×1-4L	-40℃ to +125℃	SGM2045-3.00XXDH4G/TR	20	Tape and Reel, 10000
SGM2045-3.30	XTDFN-1×1-4L	-40℃ to +125℃	SGM2045-3.30XXDH4G/TR	21	Tape and Reel, 10000
SGM2045-4.20	XTDFN-1×1-4L	-40℃ to +125℃	SGM2045-4.20XXDH4G/TR	22	Tape and Reel, 10000
SGM2045-0.60	WLCSP-0.64×0.64-4B-A	-40℃ to +125℃	SGM2045-0.60XG/TR	J1	Tape and Reel, 5000
SGM2045-0.80	WLCSP-0.64×0.64-4B-A	-40℃ to +125℃	SGM2045-0.80XG/TR	J2	Tape and Reel, 5000
SGM2045-0.85	WLCSP-0.64×0.64-4B-A	-40℃ to +125℃	SGM2045-0.85XG/TR	J4	Tape and Reel, 5000
SGM2045-1.00	WLCSP-0.64×0.64-4B-A	-40℃ to +125℃	SGM2045-1.00XG/TR	J5	Tape and Reel, 5000
SGM2045-1.05	WLCSP-0.64×0.64-4B-A	-40℃ to +125℃	SGM2045-1.05XG/TR	JA	Tape and Reel, 5000
SGM2045-1.10	WLCSP-0.64×0.64-4B-A	-40℃ to +125℃	SGM2045-1.10XG/TR	JD	Tape and Reel, 5000
SGM2045-1.20	WLCSP-0.64×0.64-4B-A	-40℃ to +125℃	SGM2045-1.20XG/TR	K9	Tape and Reel, 5000
SGM2045-1.75	WLCSP-0.64×0.64-4B-A	-40℃ to +125℃	SGM2045-1.75XG/TR	1P	Tape and Reel, 5000
SGM2045-1.80	WLCSP-0.64×0.64-4B-A	-40℃ to +125℃	SGM2045-1.80XG/TR	KA	Tape and Reel, 5000
SGM2045-1.825	WLCSP-0.64×0.64-4B-A	-40℃ to +125℃	SGM2045-1.825XG/TR	4N	Tape and Reel, 5000
SGM2045-2.50	WLCSP-0.64×0.64-4B-A	-40℃ to +125℃	SGM2045-2.50XG/TR	KB	Tape and Reel, 5000
SGM2045-2.80	WLCSP-0.64×0.64-4B-A	-40℃ to +125℃	SGM2045-2.80XG/TR	KD	Tape and Reel, 5000
SGM2045-3.00	WLCSP-0.64×0.64-4B-A	-40℃ to +125℃	SGM2045-3.00XG/TR	KF	Tape and Reel, 5000
SGM2045-3.30	WLCSP-0.64×0.64-4B-A	-40℃ to +125℃	SGM2045-3.30XG/TR	L2	Tape and Reel, 5000
SGM2045-4.20	WLCSP-0.64×0.64-4B-A	-40℃ to +125℃	SGM2045-4.20XG/TR	L4	Tape and Reel, 5000

MARKING INFORMATION



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

IN to GND ..... -0.3V to 6V
OUT to GND ..... -0.3V to (V_{IN} + 0.3V)
EN to GND ..... -0.3V to 6V
Package Thermal Resistance
XTDFN-1×1-4L, θ_{JA} ..... 242℃/W
XTDFN-1×1-4L, θ_{JB} ..... 107℃/W
XTDFN-1×1-4L, θ_{JC} ..... 238℃/W
WLCSP-0.64×0.64-4B-A, θ_{JA} ..... 285℃/W
WLCSP-0.64×0.64-4B-A, θ_{JB} ..... 50℃/W
WLCSP-0.64×0.64-4B-A, θ_{JC} ..... 116℃/W
Junction Temperature ..... +150℃
Storage Temperature Range ..... -65℃ to +150℃
Lead Temperature (Soldering, 10s) ..... +260℃
ESD Susceptibility
HBM 8000V
CDM 1000V

RECOMMENDED OPERATING CONDITIONS

Input Voltage Range ..... 1.1V to 5.5V
Enable Input Voltage Range ..... 0V to 5.5V
Input Effective Capacitance, C_{IN} ..... 0.1μF (MIN)
Output Effective Capacitance, C_{OUT} ..... 0.5μF to 200μF
Operating Junction Temperature Range ..... -40℃ to +125℃

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

ESD SENSITIVITY CAUTION

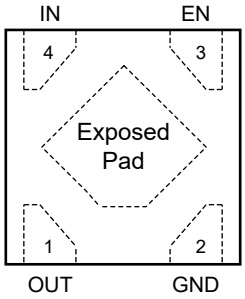
This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

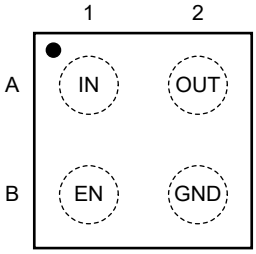
PIN CONFIGURATIONS

(TOP VIEW)



XTDFN-1×1-4L

(TOP VIEW)



WLCSP-0.64×0.64-4B-A

PIN DESCRIPTION

PIN		NAME	FUNCTION
XTDFN-1×1-4L	WLCSP-0.64×0.64-4B-A		
1	A2	OUT	Regulated Output Voltage Pin. It is recommended to use an output capacitor with effective capacitance in the range of 0.5μF to 200μF. The capacitor should be located very close to this pin.
2	B2	GND	Ground.
3	B1	EN	Enable Pin. Drive EN high to turn on the regulator. Drive EN low to turn off the regulator. The EN pin has an internal 0.03μA pull-down current source which ensures that the device is turned off when the EN pin is floated. This pin must be connected to IN pin if enable functionality is not used.
4	A1	IN	Input Voltage Supply Pin. It is recommended to use a 1μF or larger ceramic capacitor from IN pin to ground.
Exposed Pad	—	—	Exposed Pad. Exposed pad is internally connected to GND. Connect it to a large ground plane to maximize thermal performance.

ELECTRICAL CHARACTERISTICS

(V_{IN} = ($V_{OUT(NOM)}$ + 0.3V) or 1.1V (whichever is greater), V_{EN} = V_{IN}, C_{IN} = C_{OUT} = 1μF, T_J = -40℃ to +125℃, typical values are at T_J = +25℃, unless otherwise noted.)

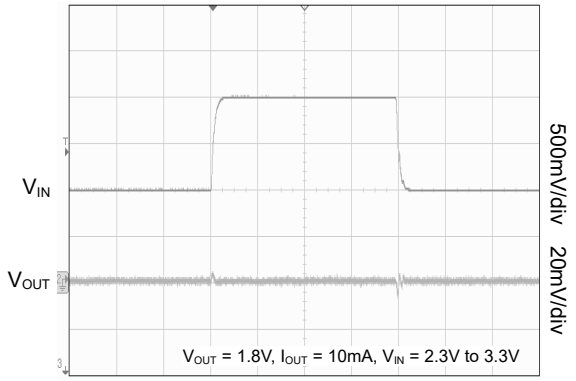
PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Input Voltage Range	V_{IN}	I_{OUT} = 60mA		1.1		5.5	V
		I_{OUT} = 100mA		1.2		5.5	
		I_{OUT} = 200mA		1.3		5.5	
		I_{OUT} = 300mA		1.4		5.5	
Output Voltage Accuracy	V_{OUT}	V_{IN} = ($V_{OUT(NOM)}$ + 0.3V) to 5.5V, I_{OUT} = 0.1mA, T_J = +25℃		-1		1	%
		V_{IN} = ($V_{OUT(NOM)}$ + 0.3V) to 5.5V, I_{OUT} = 0.1mA to 300mA		-2.5		2.5	
Line Regulation	ΔV_{LNR}	V_{IN} = ($V_{OUT(NOM)}$ + 0.3V) to 5.5V, I_{OUT} = 0.1mA			0.05	2.5	mV
Load Regulation	$\Delta V_{LDR}/V_{OUT}$	I_{OUT} = 0.1mA to 300mA			0.4	10	mV/V
Output Current Limit	I_{LIMIT}	V_{OUT} = 90% × $V_{OUT(NOM)}$, V_{IN} = ($V_{OUT(NOM)}$ + 0.3V) or 1.4V	T_J = -20℃ to +125℃	300	600		mA
			T_J = -40℃ to +125℃	260	600		
Short-Circuit Current	I_{SHORT}	V_{OUT} = 0V			380		mA
Quiescent Current	I_Q	I_{OUT} = 0mA			15	40	μA
Dropout Voltage [1]	V_{DROP}	I_{OUT} = 60mA	1.05V ≤ $V_{OUT(NOM)}$ < 1.2V		65	110	mV
		I_{OUT} = 100mA	1.05V ≤ $V_{OUT(NOM)}$ < 1.2V		100	160	
			1.2V ≤ $V_{OUT(NOM)}$ < 1.5V		65	110	
		I_{OUT} = 200mA	1.05V ≤ $V_{OUT(NOM)}$ < 1.2V		185	260	
			1.2V ≤ $V_{OUT(NOM)}$ < 1.5V		125	210	
		I_{OUT} = 300mA	1.05V ≤ $V_{OUT(NOM)}$ < 1.2V		260	360	
			1.2V ≤ $V_{OUT(NOM)}$ < 1.5V		185	300	
			1.5V ≤ $V_{OUT(NOM)}$ < 1.8V		125	220	
		I_{OUT} = 300mA, XTDFN-1×1-4L	1.8V ≤ $V_{OUT(NOM)}$ < 2.8V		100	190	
			2.8V ≤ $V_{OUT(NOM)}$ ≤ 4.2V		70	150	
		I_{OUT} = 300mA, WLCSP-0.64×0.64-4B-A	1.8V ≤ $V_{OUT(NOM)}$ < 2.8V		80	130	
			2.8V ≤ $V_{OUT(NOM)}$ ≤ 4.2V		50	120	
EN Input Threshold	V_{IH}	V_{IN} = 1.1V to 5.5V		0.7			V
	V_{IL}					0.3	
EN Pull-Down Current	I_{EN}	V_{EN} = V_{IN} = 5.5V			0.03	1	μA
Shutdown Current	I_{SHDN}	V_{EN} = 0V, V_{IN} = 5.5V			0.03	2	μA
Turn-On Time	t_{ON}	From EN rising from 0V to V_{IN} to 90% × $V_{OUT(NOM)}$, no load			100	240	μs
Power Supply Rejection Ratio	PSRR	I_{OUT} = 20mA, V_{IN} = $V_{OUT(NOM)}$ + 1V	f = 100Hz		90		dB
			f = 1kHz		92		
			f = 10kHz		80		
			f = 100kHz		55		
Output Voltage Noise	e_n	f = 10Hz to 100kHz, I_{OUT} = 20mA			9.5		μV_{RMS}
Output Discharge Resistance	R_{DIS}	V_{EN} = 0V, V_{OUT} = 0.2V, V_{IN} = 3.3V			60		Ω
Thermal Shutdown Temperature	T_{SHDN}				160		℃
Thermal Shutdown Hysteresis	ΔT_{SHDN}				20		℃

NOTE:
1. Dropout voltage is characterized when V_{OUT} falls 50mV below $V_{OUT(NOM)}$.

TYPICAL PERFORMANCE CHARACTERISTICS

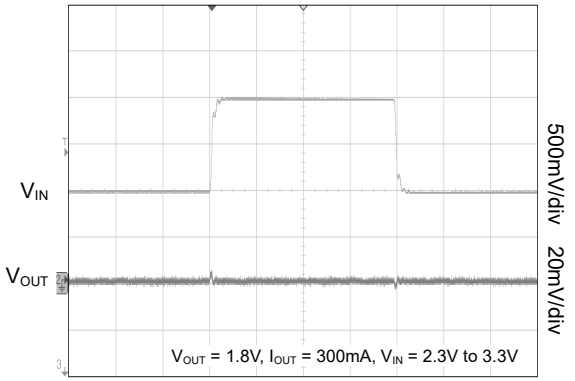
T_J = +25℃, V_{IN} = ($V_{OUT(NOM)}$ + 0.3V) or 1.1V (whichever is greater), V_{EN} = V_{IN}, C_{IN} = C_{OUT} = 1μF, unless otherwise noted.

Line Transient Response



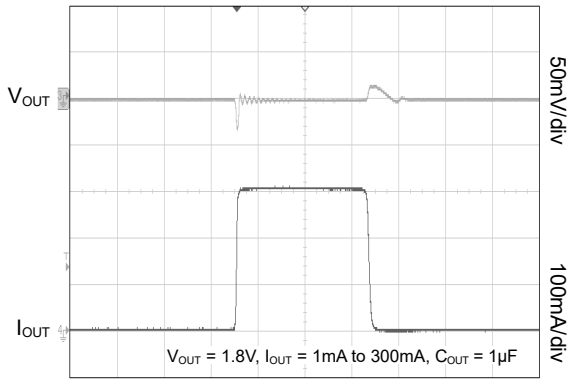
Time (20μs/div)

Line Transient Response



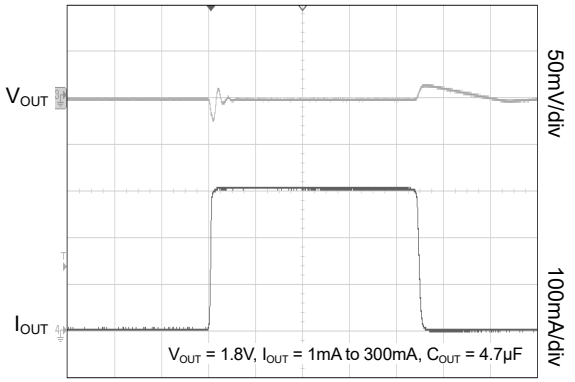
Time (20μs/div)

Load Transient Response



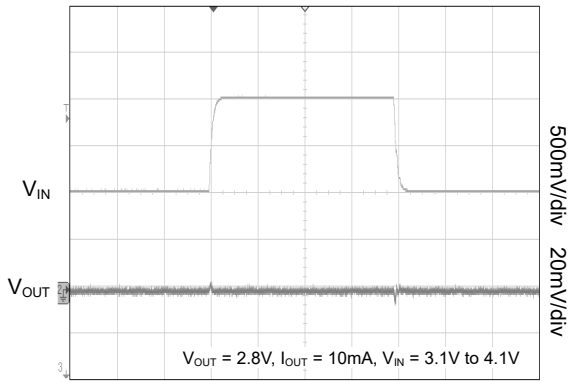
Time (10μs/div)

Load Transient Response



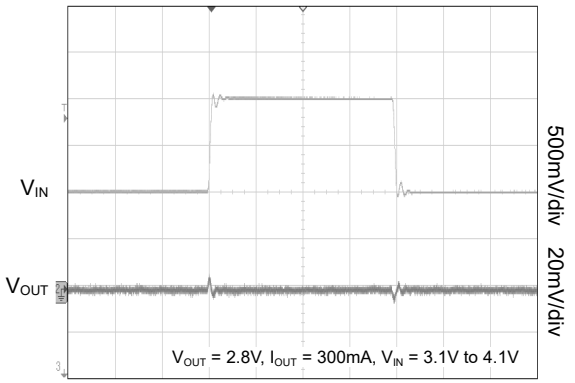
Time (10μs/div)

Line Transient Response



Time (20μs/div)

Line Transient Response

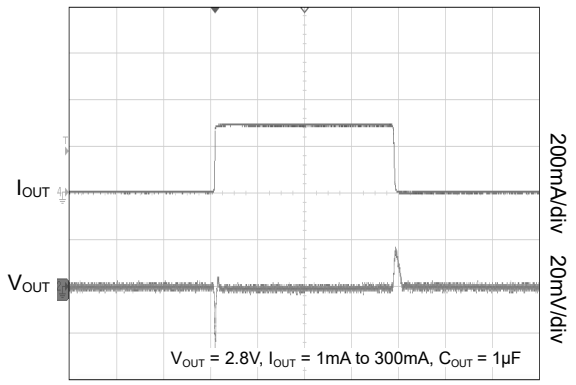


Time (20μs/div)

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

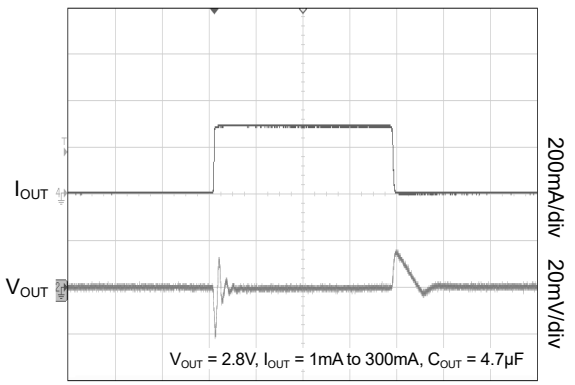
T_J = +25℃, V_{IN} = ($V_{OUT(NOM)}$ + 0.3V) or 1.1V (whichever is greater), V_{EN} = V_{IN}, C_{IN} = C_{OUT} = 1μF, unless otherwise noted.

Load Transient Response



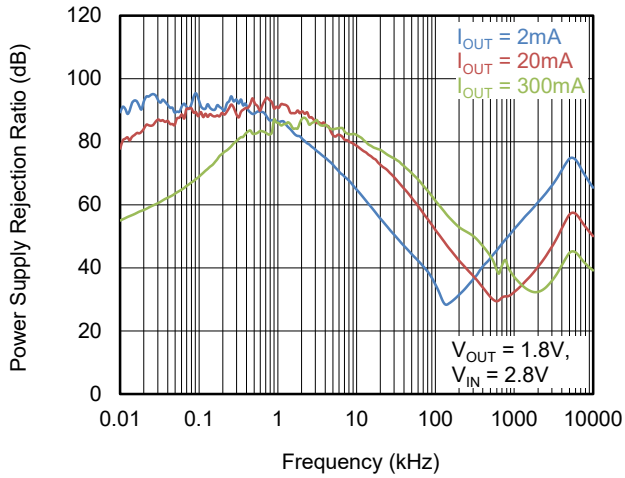
Time (20μs/div)

Load Transient Response

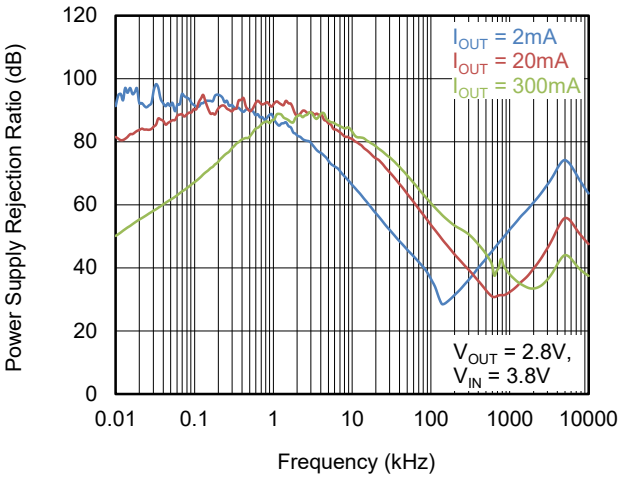


Time (20μs/div)

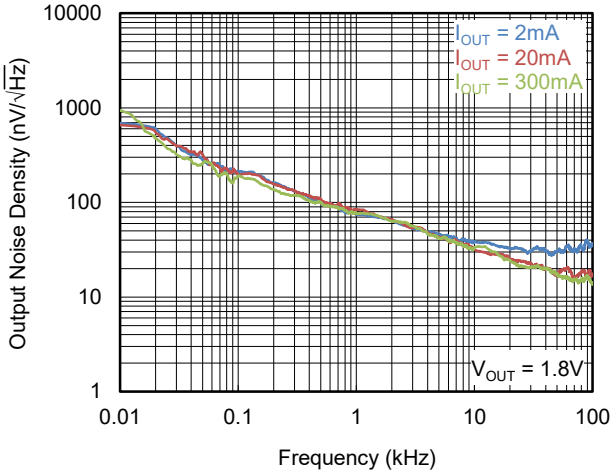
Power Supply Rejection Ratio vs. Frequency



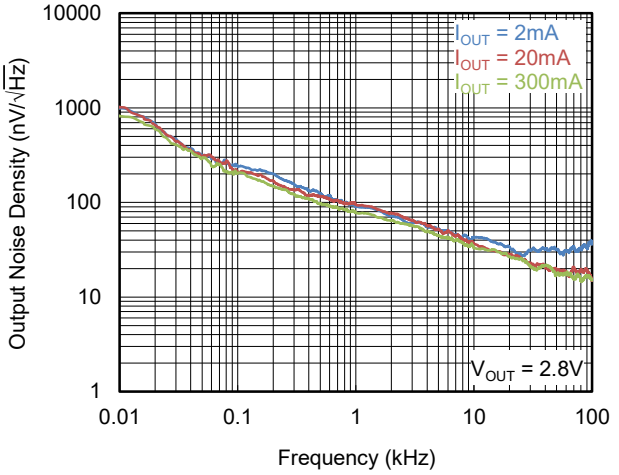
Power Supply Rejection Ratio vs. Frequency



Output Noise Density vs. Frequency



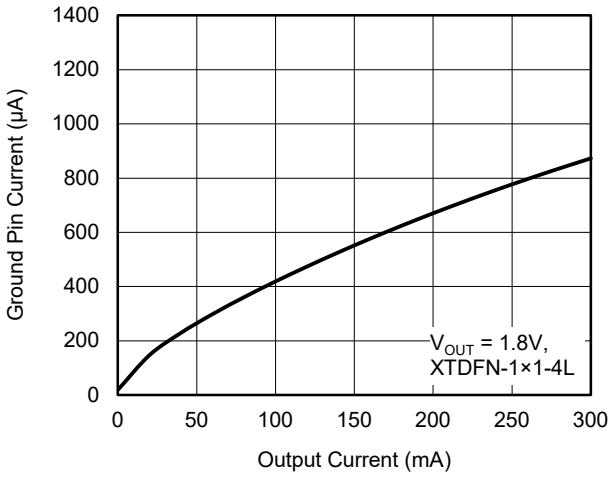
Output Noise Density vs. Frequency



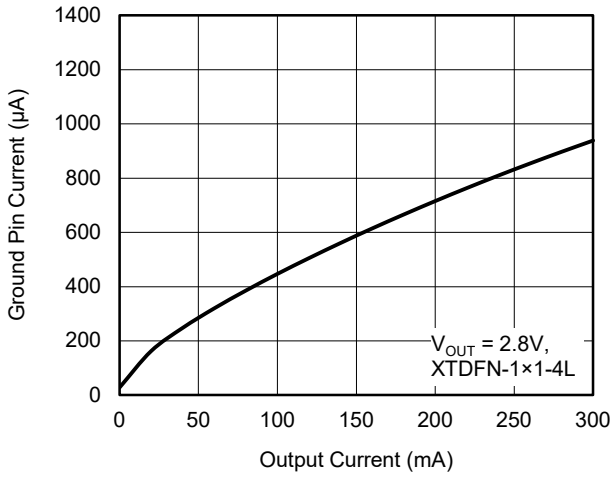
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

T_J = +25℃, V_{IN} = ($V_{OUT(NOM)}$ + 0.3V) or 1.1V (whichever is greater), V_{EN} = V_{IN}, C_{IN} = C_{OUT} = 1μF, unless otherwise noted.

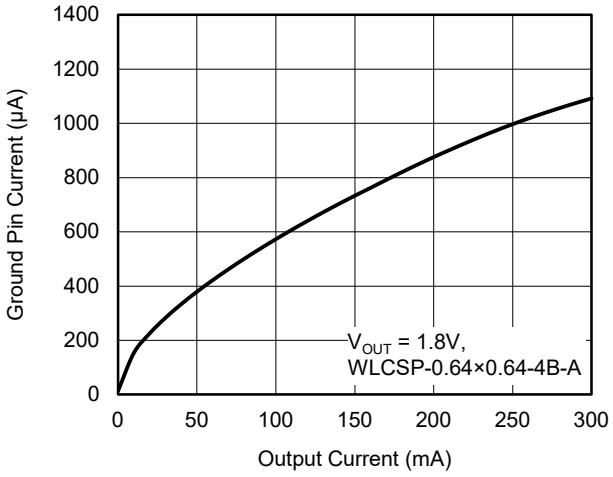
Ground Pin Current vs. Output Current



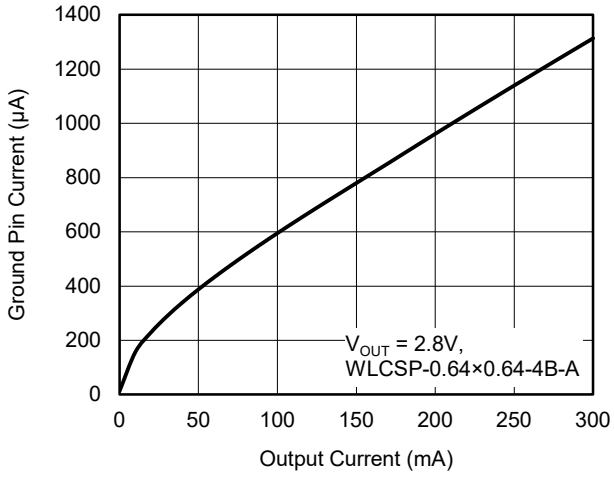
Ground Pin Current vs. Output Current



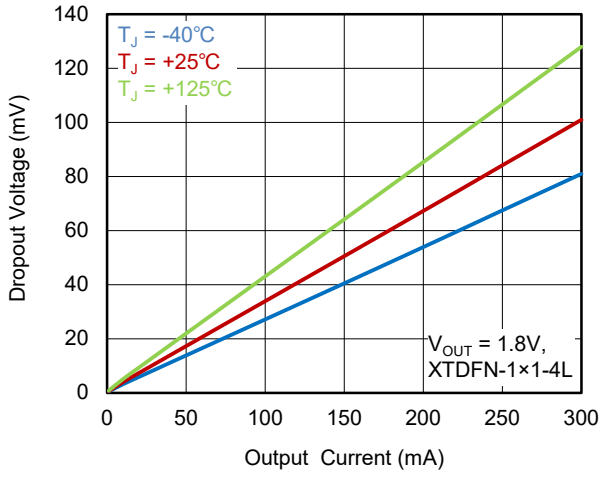
Ground Pin Current vs. Output Current



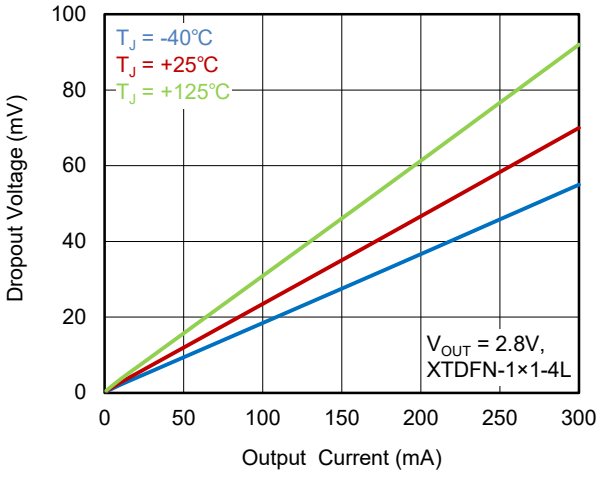
Ground Pin Current vs. Output Current



Dropout Voltage vs. Output Current



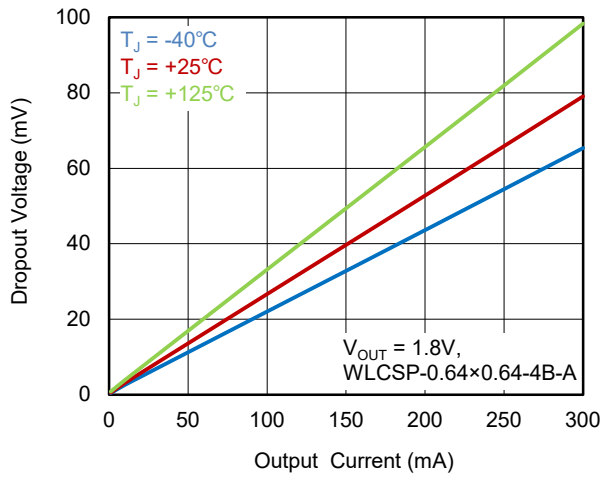
Dropout Voltage vs. Output Current



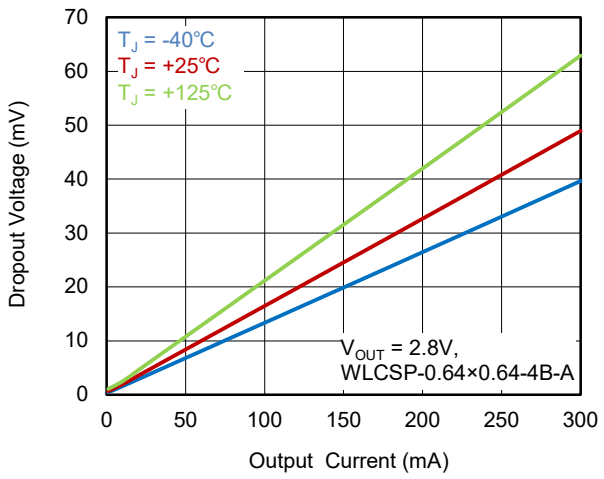
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

T_J = +25℃, V_{IN} = ($V_{OUT(NOM)}$ + 0.3V) or 1.1V (whichever is greater), V_{EN} = V_{IN}, C_{IN} = C_{OUT} = 1μF, unless otherwise noted.

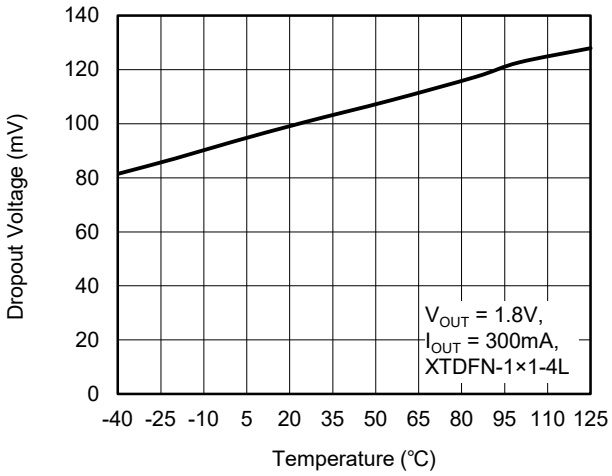
Dropout Voltage vs. Output Current



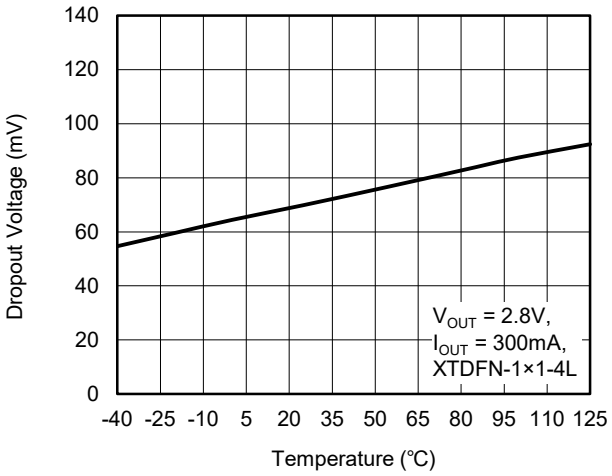
Dropout Voltage vs. Output Current



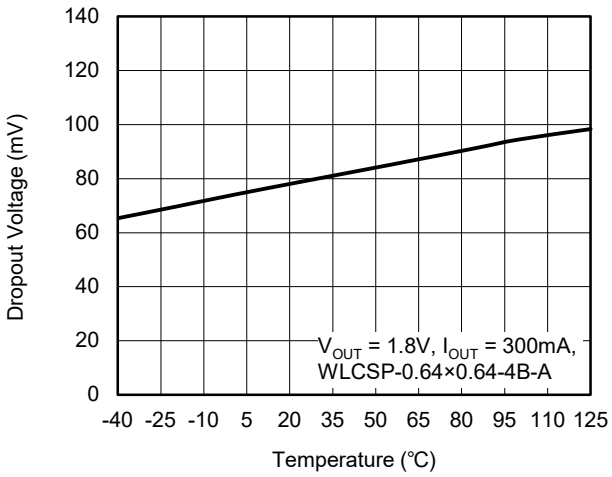
Dropout Voltage vs. Temperature



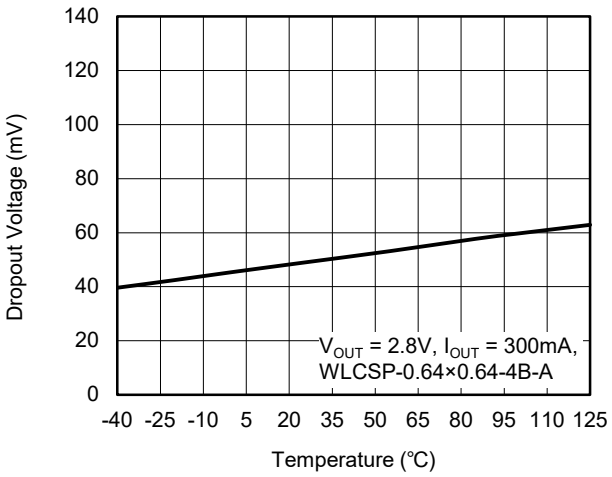
Dropout Voltage vs. Temperature



Dropout Voltage vs. Temperature



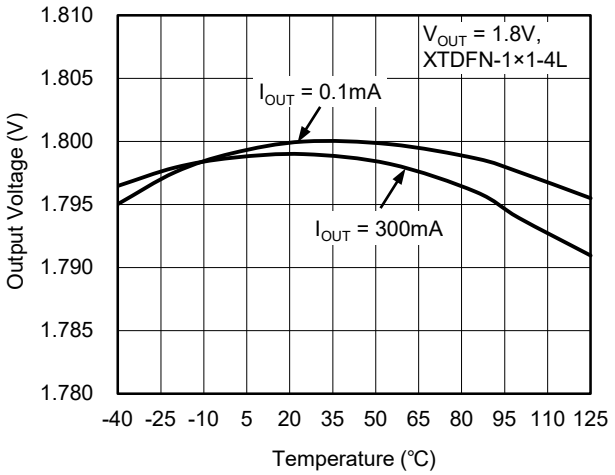
Dropout Voltage vs. Temperature



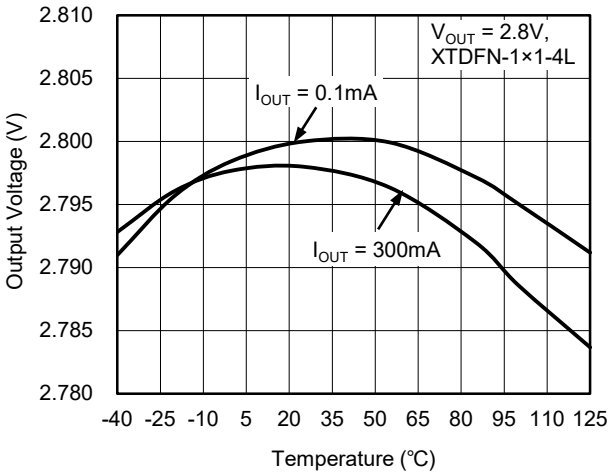
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

T_J = +25℃, V_{IN} = ($V_{OUT(NOM)}$ + 0.3V) or 1.1V (whichever is greater), V_{EN} = V_{IN}, C_{IN} = C_{OUT} = 1μF, unless otherwise noted.

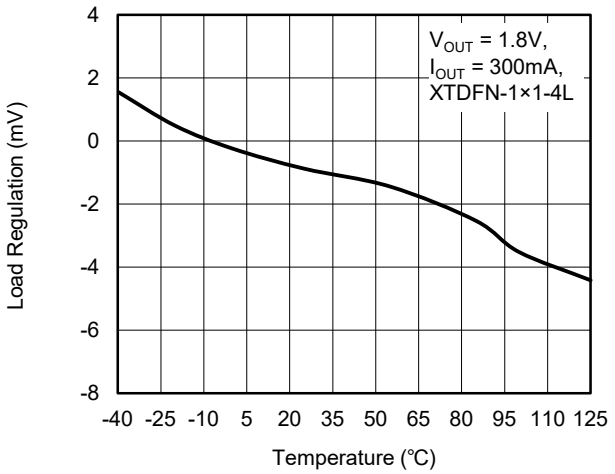
Output Voltage vs. Temperature



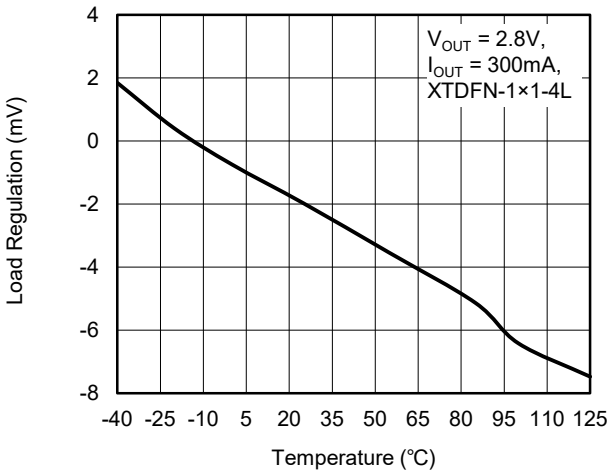
Output Voltage vs. Temperature



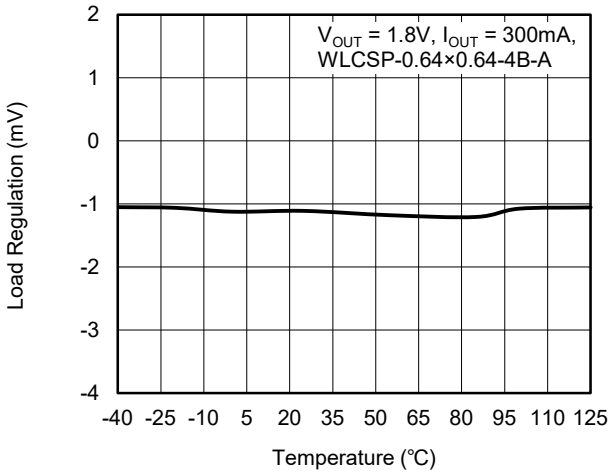
Load Regulation vs. Temperature



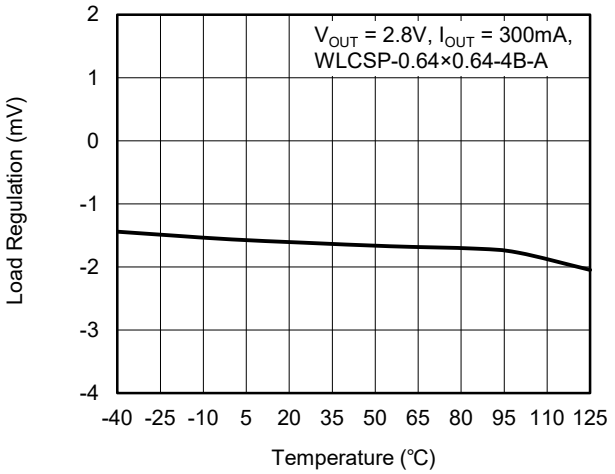
Load Regulation vs. Temperature



Load Regulation vs. Temperature



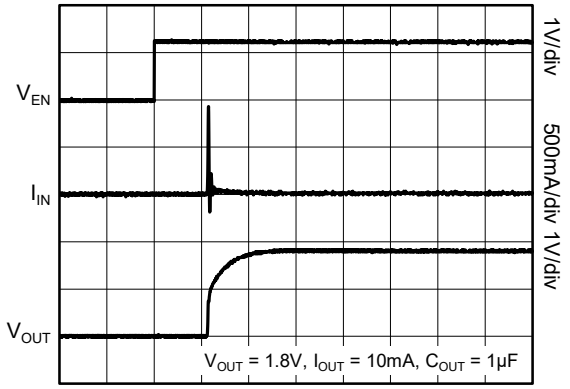
Load Regulation vs. Temperature



TYPICAL PERFORMANCE CHARACTERISTICS (continued)

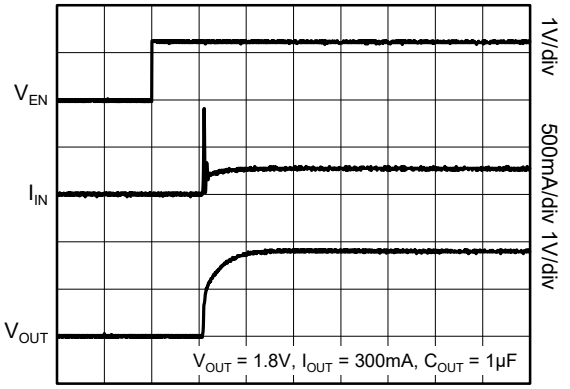
T_J = +25℃, V_{IN} = ($V_{OUT(NOM)}$ + 0.3V) or 1.1V (whichever is greater), V_{EN} = V_{IN}, C_{IN} = C_{OUT} = 1μF, unless otherwise noted.

Enable Turn-On Response



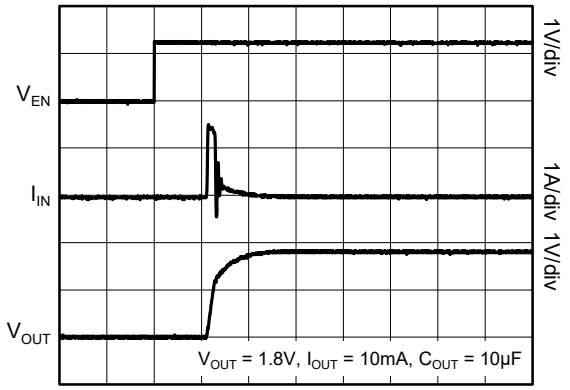
Time (50μs/div)

Enable Turn-On Response



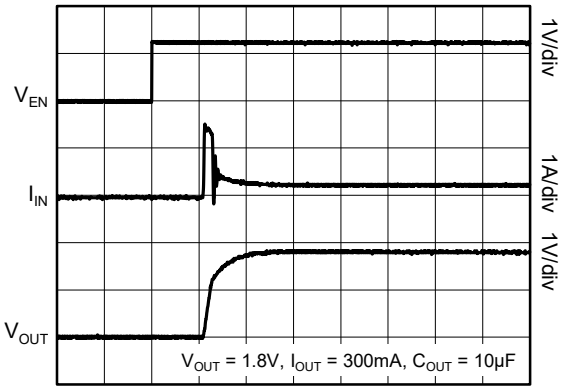
Time (50μs/div)

Enable Turn-On Response



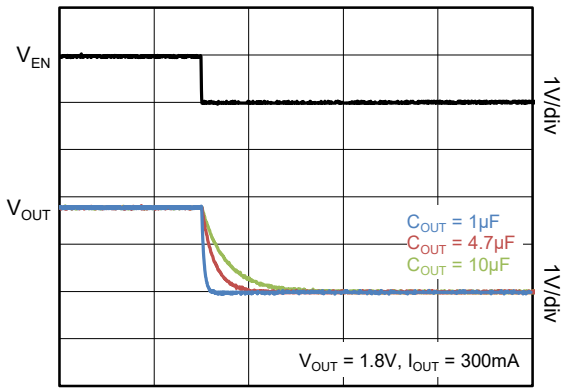
Time (50μs/div)

Enable Turn-On Response



Time (50μs/div)

Enable Turn-Off Response



Time (200μs/div)

FUNCTIONAL BLOCK DIAGRAM

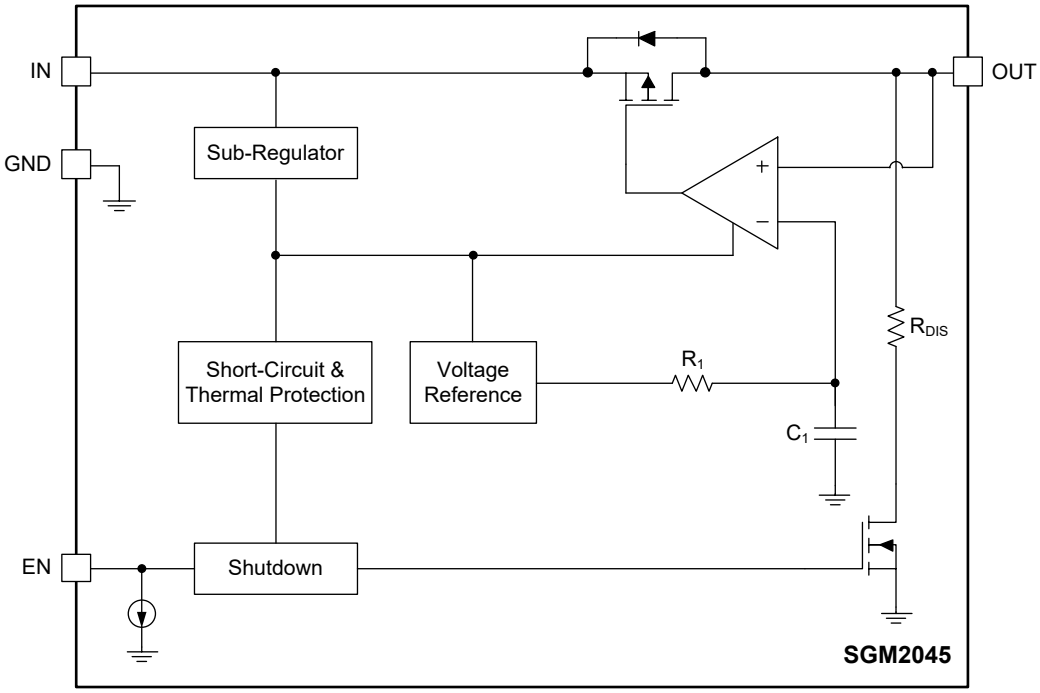


Figure 2. Block Diagram

APPLICATION INFORMATION

The SGM2045 is a low input voltage, ultra-low noise and low dropout LDO and provides 300mA output current. These features make the device a reliable solution to solve many challenging problems in the generation of clean and accurate power supply. The high performance also makes the SGM2045 useful in a variety of applications. The SGM2045 provides the protection function for output overload, output short -circuit condition and overheating.

The SGM2045 provides an EN pin as an external chip enable control to enable/disable the device. When the regulator is in shutdown state, the shutdown current consumes as low as 0.03μA (TYP).

Input Capacitor Selection (C_{IN})

The input decoupling capacitor is necessary to be connected as close as possible to the IN pin for ensuring the device stability. 0.1μF or greater X7R or X5R ceramic capacitor is selected to get good dynamic performance.

When V_{IN} is required to provide large current instantaneously, a large effective input capacitor is required. Multiple input capacitors can limit the input tracking inductance. Adding more input capacitors is available to restrict the ringing and to keep it below the device absolute maximum ratings.

Output Capacitor Selection (C_{OUT})

The output decoupling capacitor should be located as close as possible to the OUT pin. 1μF or greater X7R or X5R ceramic capacitor is selected to get good dynamic performance. The minimum effective capacitance of C_{OUT} that SGM2045 can remain stable is 0.5μF. For ceramic capacitor, temperature, DC bias and package size will change the effective capacitance, so enough margin of C_{OUT} must be considered in design. Larger capacitance and lower ESR C_{OUT} will help improve the load transient response and increase the high frequency PSRR.

Enable Control

The SGM2045 uses the EN pin to enable/disable its device and to deactivate/activate the output automatic discharge function.

When the EN pin voltage is lower than 0.3V, the device is in shutdown state, there is no current flowing from IN to OUT pins. In this state, the automatic discharge transistor is active to discharge the output voltage through a 60Ω (TYP) resistor.

When the EN pin voltage is higher than 0.7V, the device is in active state, the input voltage is regulated to the output voltage and the automatic discharge transistor is turned off.

The EN pin is pulled down by internal 0.03μA (TYP) current source when the EN pin is floated. This current source will ensure the SGM2045 in shutdown state and reduce the power dissipation in system.

Output Current Limit and Short-Circuit Protection

When overload events happen, the output current is internally limited to 600mA (TYP). When the OUT pin is shorted to ground, the short-circuit protection will limit the output current to 380mA (TYP).

Thermal Shutdown

The SGM2045 can detect the temperature of die. When the die temperature exceeds the threshold value of thermal shutdown, the SGM2045 will be in shutdown state and it will remain in this state until the die temperature decreases to +140℃.

Power Dissipation (P_D)

Thermal protection limits power dissipation in the SGM2045. When power dissipation on pass element (P_D = (V_{IN} - V_{OUT}) × I_{OUT}) is too much that raise the operation junction temperature exceeds +160℃, the OTP circuit starts the thermal shutdown function and turns the pass element off.

Therefore, thermal analysis for the chosen application is important to guarantee reliable performance over all conditions. To guarantee reliable operation, the junction temperature of the SGM2045 must not exceed +125℃.

The maximum allowable power dissipation depends on the thermal resistance of the IC package, the PCB layout, the rate of surrounding airflow, and the difference between the junction and ambient temperatures. The maximum power dissipation can be approximated using the following formula:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA} \quad (3)$$

where $T_{J(MAX)}$ is the maximum junction temperature, T_A is the ambient temperature, and θ_{JA} is the junction -to-ambient thermal resistance.

APPLICATION INFORMATION (continued)

Negatively Biased Output

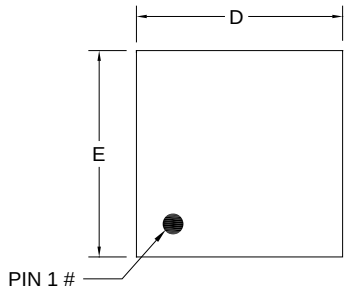
When the output is negative voltage, the chip may not start up due to parasitic effects. Ensure that the output is greater than -0.3V under all conditions. If excessive negatively biased output is expected in the application, a Schottky diode can be added between the OUT pin and GND pin.

Reverse Current

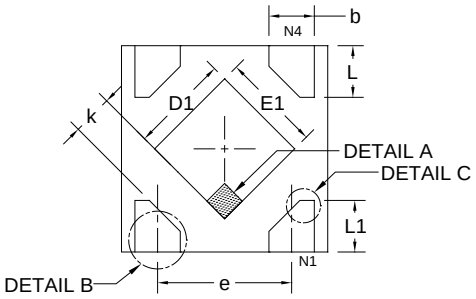
The pass transistor has an inherent body diode which will be forward biased in the case when V_{OUT} > (V_{IN} + 0.3V). If extended reverse voltage operation is anticipated, external limiting might be appropriate.

PACKAGE OUTLINE DIMENSIONS

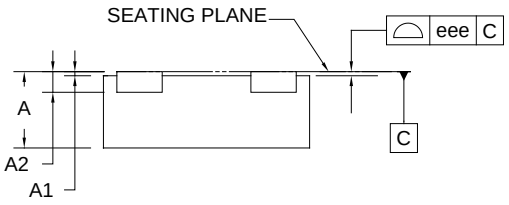
XTDFN-1×1-4L



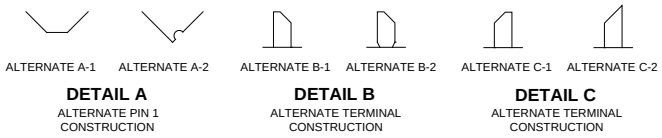
TOP VIEW



BOTTOM VIEW



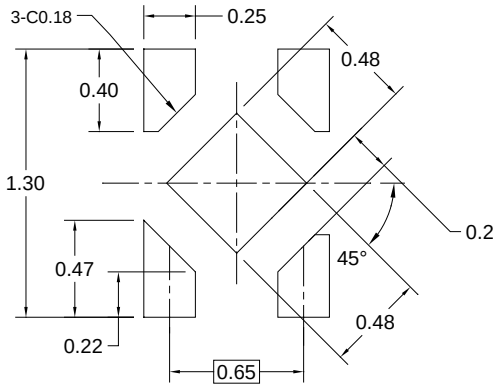
SIDE VIEW



DETAIL A
ALTERNATE PIN 1 CONSTRUCTION

DETAIL B
ALTERNATE TERMINAL CONSTRUCTION

DETAIL C
ALTERNATE TERMINAL CONSTRUCTION



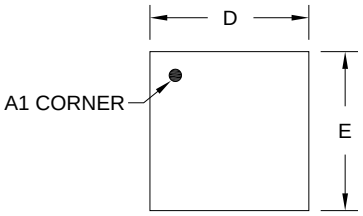
RECOMMENDED LAND PATTERN (Unit: mm)

Symbol	Dimensions In Millimeters		
	MIN	MOD	MAX
A	0.340	0.370	0.400
A1	0.000	0.020	0.050
A2	0.100 REF		
b	0.170	-	0.300
D	0.950	1.000	1.050
E	0.950	1.000	1.050
D1	0.430	0.480	0.530
E1	0.430	0.480	0.530
L	0.200	0.250	0.300
L1	0.200	-	0.370
e	0.650 BSC		
k	0.150	-	-
eee	-	0.050	-

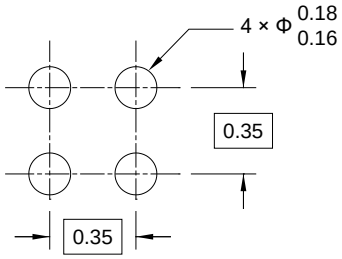
NOTE: This drawing is subject to change without notice.

PACKAGE OUTLINE DIMENSIONS

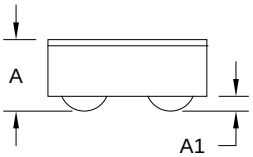
WLCSP-0.64×0.64-4B-A



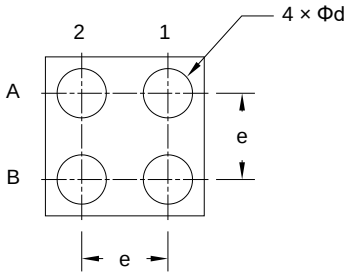
TOP VIEW



RECOMMENDED LAND PATTERN (Unit: mm)



SIDE VIEW



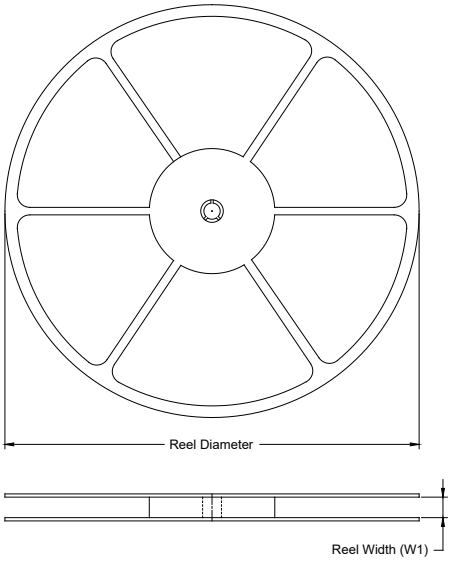
BOTTOM VIEW

Symbol	Dimensions In Millimeters		
	MIN	MOD	MAX
A	0.262	0.290	0.318
A1	0.050	0.060	0.070
D	0.620	0.645	0.670
E	0.620	0.645	0.670
d	0.190	0.200	0.210
e	0.350 BSC		

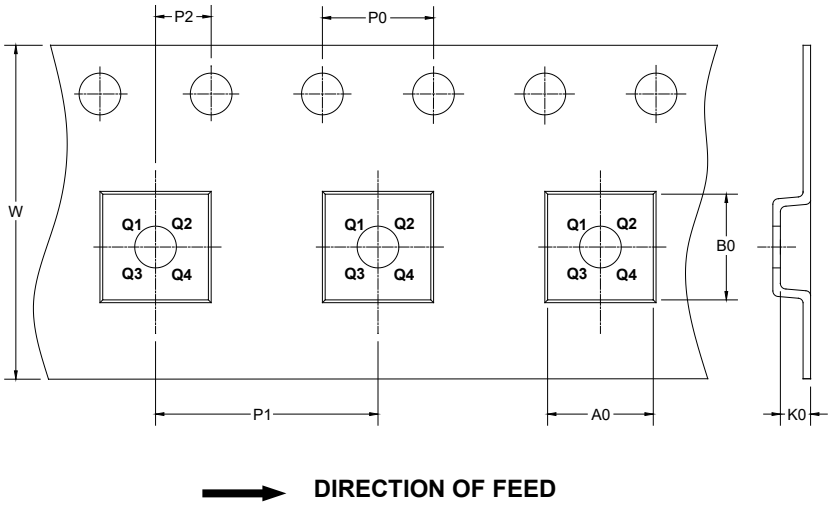
NOTE: This drawing is subject to change without notice.

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



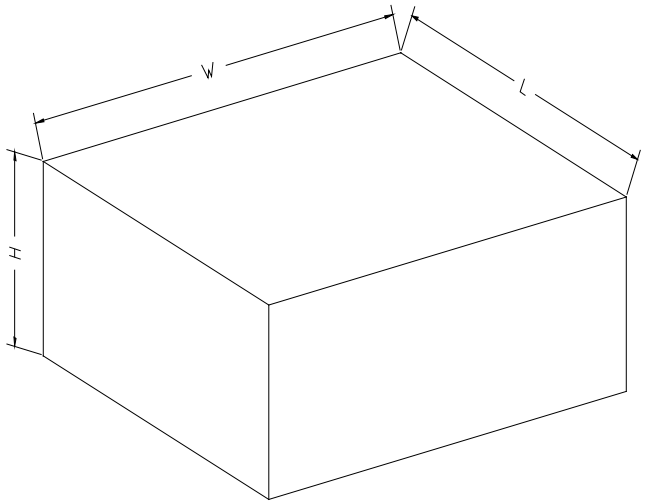
NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
XTDFN-1×1-4L	7″	9.5	1.16	1.16	0.50	4.0	2.0	2.0	8.0	Q1
WLCSP-0.64×0.64-4B-A	7″	9.5	0.74	0.74	0.37	4.0	4.0	2.0	8.0	Q1

DD0001

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7″ (Option)	368	227	224	8
7″	442	410	224	18

DD0002